

65V NPN MATCHED PAIR SMALL SIGNAL TRANSISTOR IN SOT363

Features

- Ultra-Small Surface Mount Package
- Current Gain Matching
- Base-Emitter Voltage Matching
- Ideally Suited for Automated Insertion
- For Switching and AF Amplifier Application
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

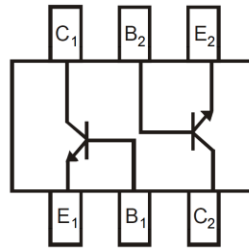
Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish — Matte Tin Finish. Solderable per MIL-STD-202, Method 208 **(e3)**
- Weight: 0.006 grams (Approximate)

SOT363



Top View



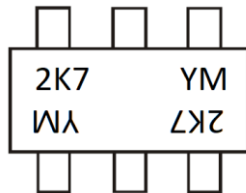
Device Schematic
Top View

Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
BCM846BS-7	AEC-Q101	2K7	7	8	3,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



2K7 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: F = 2018)
M = Month (ex: 9 = September)

Date Code Key

Year Code	2018	2019	2020	2021	2022	2023	2024	2025
	F	G	H	I	J	K	L	M

Month Code	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	80	V
Collector-Emitter Voltage	V _{CEO}	65	V
Emitter-Base Voltage	V _{EBO}	6	V
Collector Current	I _C	100	mA
Peak Collector Current	I _{CM}	200	mA
Peak Base Current	I _{BM}	200	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	200	mW
Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

ESD Ratings (Note 6)

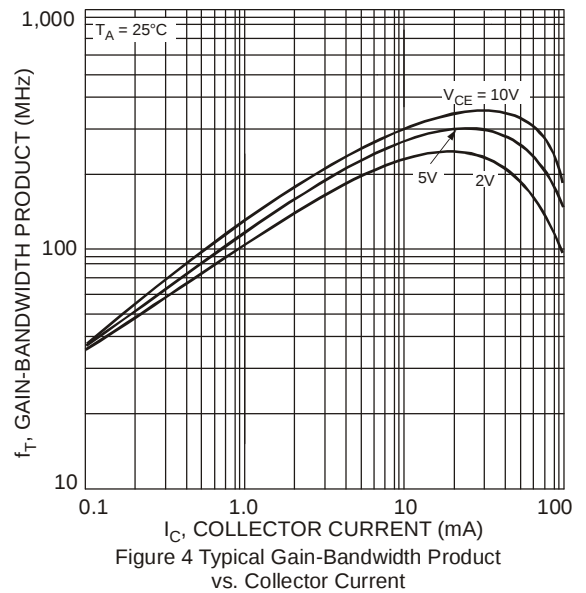
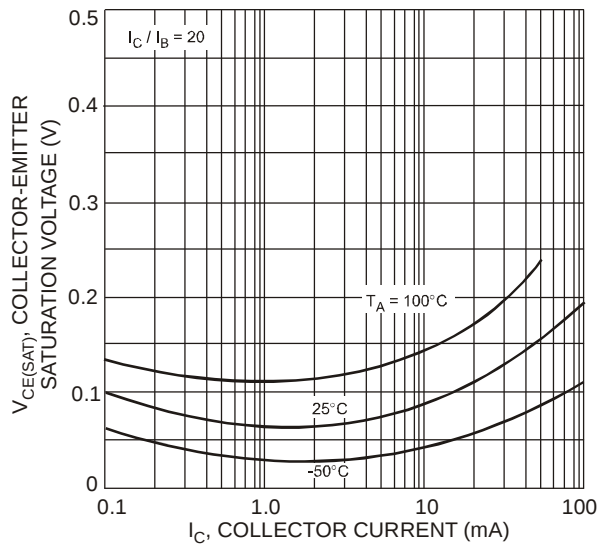
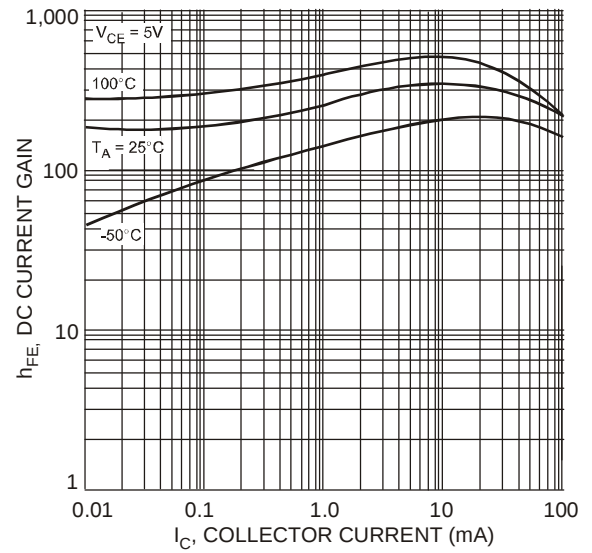
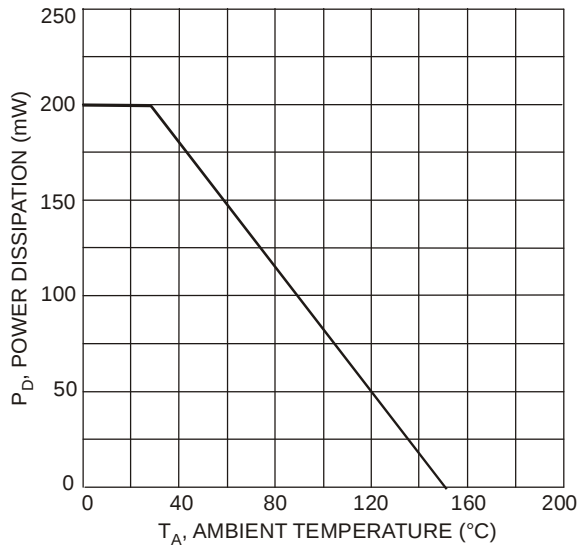
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic (Note 7)	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	80	—	—	V	I _C = 100μA, I _B = 0
Collector-Emitter Breakdown Voltage	BV _{CEO}	65	—	—	V	I _C = 10mA, I _B = 0
Emitter-Base Breakdown Voltage	BV _{EBO}	6	—	—	V	I _E = 100μA, I _C = 0
DC Current Gain	h _{FE}	200	—	450	—	V _{CE} = 5V, I _C = 2mA
DC Current Gain Matching	h _{FE1} /h _{FE2}	0.9	1	1.1	—	V _{CE} = 5V, I _C = 2mA
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	—	—	100 400	mV	I _C = 10mA, I _B = 0.5mA I _C = 100mA, I _B = 5mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	—	755 905	—	mV	I _C = 10mA, I _B = 0.5mA I _C = 100mA, I _B = 5mA
Base-Emitter Voltage	V _{BE(ON)}	610	665	710	mV	V _{CE} = 5V, I _C = 2mA
Base-Emitter Voltage Matching	V _{BE1(ON)} - V _{BE2(ON)}	-2	—	2	mV	V _{CE} = 5V, I _C = 2mA
Collector-Cutoff Current	I _{CBO}	—	—	15 5	nA μA	V _{CB} = 40V V _{CB} = 40V, T _A = +125°C
Emitter-Cutoff Current	I _{EBO}	—	—	20	nA	V _{EB} = 5V, I _C = 0
Gain Bandwidth Product	f _T	100	—	—	MHz	V _{CE} = 5V, I _C = 10mA, f = 100MHz
Collector-Base Capacitance	C _{CBO}	—	2	3	pF	V _{CB} = 10V, f = 1MHz
Emitter-Base Capacitance	C _{EBO}	—	11	—	pF	V _{EB} = 0.5V, f = 1MHz

- Notes:
5. For a device mounted with the collector lead on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.
 6. Refer to JEDEC specification JESD22-A114 and JESD22-A115.
 7. Short duration pulse test used to minimize self-heating effect.

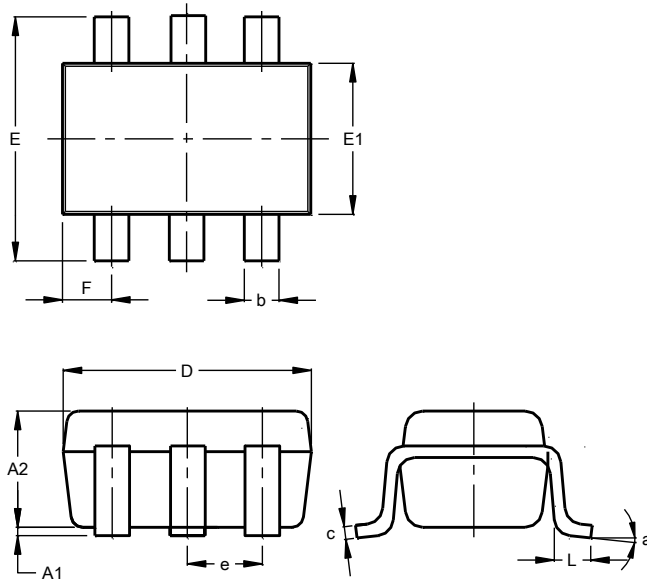
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363

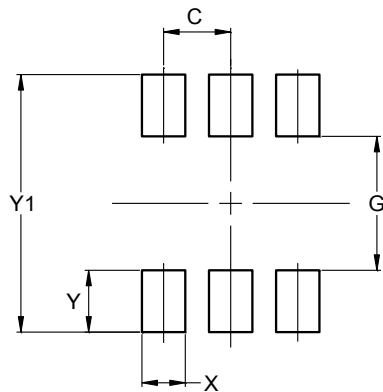


SOT363			
Dim	Min	Max	Typ
A1	0.00	0.10	0.05
A2	0.90	1.00	0.95
b	0.10	0.30	0.25
c	0.10	0.22	0.11
D	1.80	2.20	2.15
E	2.00	2.20	2.10
E1	1.15	1.35	1.30
e	0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363



Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

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